UNISONIC TECHNOLOGIES CO., LTD

UT80N055M

Preliminary

POWER MOSFET

80A, 55V N-CHANNEL POWER MOSFET

DESCRIPTION

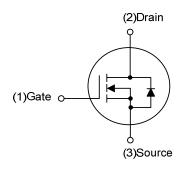
The UTC **UT80N055M** is a N-channel Power MOSFET, it uses UTC's advanced technology to provide the customers with low R_{DS(ON)} characteristic by high cell density trench technology.

The UTC **UT80N055M** is suitable for high efficiency synchronous rectification in SMPS, UPS, hard switched and high frequency circuits.

■ FEATURES

- * $R_{DS(ON)} \le 5.0 \text{ m}\Omega$ @ $V_{GS}=10V$, $I_D=40A$
- * $R_{DS(ON)} \le 7.0 \text{ m}\Omega$ @ V_{GS} =4.5V, I_D =40A
- * Low capacitance
- * Low gate charge
- * Fast switching capability
- * Avalanche energy specified

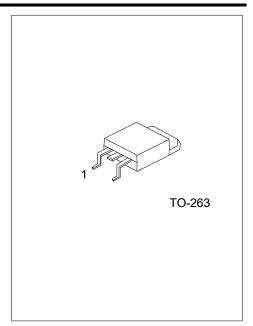
■ SYMBOL



ORDERING INFORMATION

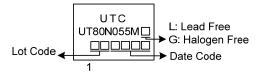
	Ordering Number		Dookogo	Pin Assignment			Da alsima	
	Lead Free	Halogen Free	Package	1	2	3	Packing	
	UT80N055ML-TQ2-T	UT80N055MG-TQ2-T	TO-263	G	D	S	Tube	
	UT80N055ML-TQ2-R	UT80N055MG-TQ2-R	TO-263	G	D	S	Tape Reel	
١	Note: Pin Assignment: G: Gate D: Drain S: Source							

UT80N055MG-TQ2-T
(1)Packing Type
(1) T: Tube, R: Tape Reel
(2) TQ2: TO-263
(3)Green Package
(3) G: Halogen Free and Lead Free, L: Lead Free



www.unisonic.com.tw 1 of 7

■ MARKING



■ ABSOLUTE MAXIMUM RATING (T_C=25°C unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	55	V	
Gate-Source Voltage		V_{GSS}	±20	V	
Duain Cumant	DC	I _D	80	Α	
Drain Current	Pulsed (Note 2)	I _{DM}	160	Α	
Avalanche Energy	valanche Energy Single Pulsed (Note 3)		185	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.1	V/ns	
Power Dissipation		P _D	93	W	
Junction Temperature		TJ	+150	°C	
Storage Temperature Range		T _{STG}	-55 ~ + 150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 0.1mH, I_{AS} = 61A, V_{DD} = 25V, R_G = 25 Ω , Starting T_J = 25°C
- 4. $I_{SD} \le 30 A$, $di/dt \le 200 A/\mu s$, $V_{DD} \le V_{(BR)DSS}$, $T_J = 25 ^{\circ} C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	62.5	°C/W
Junction to Case	θις	1.34	°C/W

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

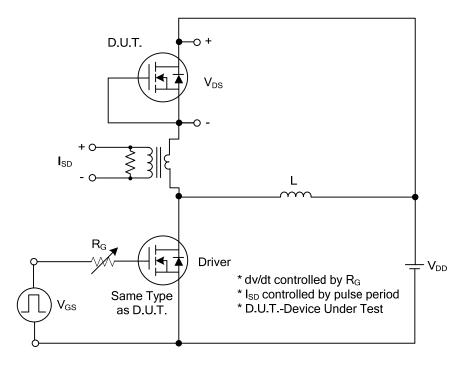
■ ELECTRICAL CHARACTERISTICS (T_A=25°C unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT			
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	55			V			
Drain-Source Leakage Current	I _{DSS}	V _{DS} =55V, V _{GS} =0V			1	μA			
Forward		V _{GS} =+20V, V _{DS} =0V			+100	nΑ			
Gate-Source Leakage Current Reverse	I _{GSS}	V _{GS} =-20V, V _{DS} =0V			-100	nA			
ON CHARACTERISTICS									
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.0		3.0	V			
Static Drain-Source On-State Resistance	D	V_{GS} =10V, I_D =40A			5.0	mΩ			
Static Drain-Source On-State Resistance	R _{DS(ON)}	$V_{GS} = 4.5 V, I_D = 40 A$			7.0	mΩ			
DYNAMIC PARAMETERS									
Input Capacitance	C _{ISS}			5916		pF			
Output Capacitance	Coss	V_{GS} =0V, V_{DS} =25V, f=1.0MHz		577		pF			
Reverse Transfer Capacitance	C _{RSS}			469		pF			
SWITCHING PARAMETERS									
Total Gate Charge	Q_{G}	V _{DS} =44V, V _{GS} =10V, I _D =80A		185		nC			
Gate to Source Charge	Q _{GS}	(Note 1, 2)		13		nC			
Gate to Drain Charge	Q_GD	(Note 1, 2)		86		nC			
Turn-ON Delay Time	t _{D(ON)}			15		ns			
Rise Time	t _R	V _{DD} =27.5V, V _{GS} =10V, I _D =80A,		17		ns			
Turn-OFF Delay Time	t _{D(OFF)}	R _G =3Ω (Note 1, 2)		90		ns			
Fall-Time	t _F			42		ns			
SOURCE-DRAIN DIODE RATINGS AND	CHARACTER	ISTICS							
Maximum Continuous Drain-Source Diode	Is				80	Α			
Forward Current					00	٨			
Maximum Pulsed Drain-Source Diode	Іѕм				160	Α			
Forward Current					100	^			
Diode Forward Voltage	V _{SD}	I _F =80A, V _{GS} =0V			1.4	V			
Reverse Recovery Time (Note 1)	t _{rr}	I _S =30A, V _{GS} =0V,		98		nS			
Reverse Recovery Charge	Qrr	dI _F /dt =100A/μs		166		nC			

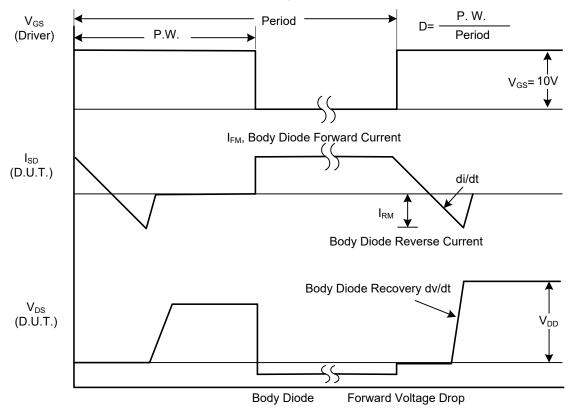
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

^{2.} Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

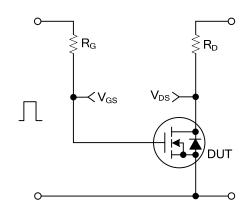


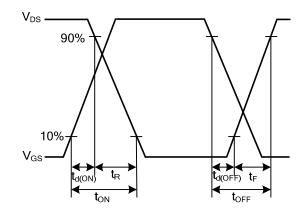
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

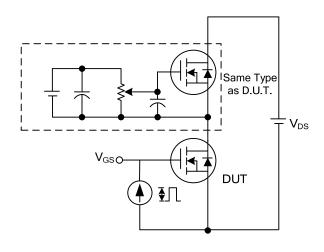
TEST CIRCUITS AND WAVEFORMS

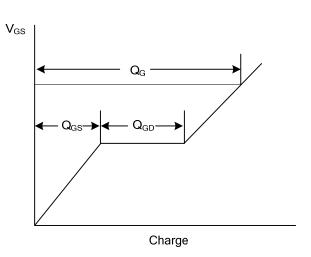




itching Test Circuit

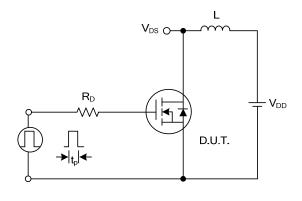
Switching Waveforms

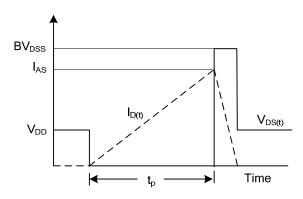




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. UTC reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

